## COPPACED DEPOS

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE 11-3

In re the Application of:

Russell et al.

Docket No.: TI-25084

Serial No:

TBD

Examiner: TBD

Filed:

08/23/01

Art Unit:

**TBD** 

For:

IMPROVED DIELECTRIC LAYER LINER FOR AN INTEGRATED

CIRCUIT STRUCTURE

## PRELIMINARY AMENDMENT

August 23, 2001

**Assistant Commissioner for Patents** 

Washington, DC 20231

Dear Sir:

Please amend the above referenced application as follows:

In the Specification:

Page 1, before line 1, insert -- This application claims priority under 35 USC §

D

119(e)(1) of provisional application numbers 60/228,912 filed 08/29/00.F-